UNISONIC TECHNOLOGIES CO., LTD

9NM65-V **Power MOSFET**

9A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

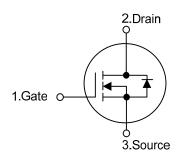
DESCRIPTION

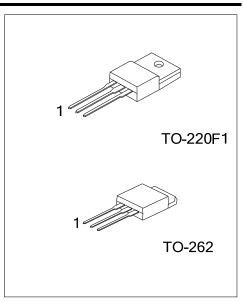
The UTC 9NM65-V is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)}$ < 0.62 Ω @ V_{GS} = 10V, I_{D} = 4.5A
- * Fast Switching Capability
- * Avalanche Energy Tested
- * Improved dv/dt Capability, High Ruggedness

SYMBOL

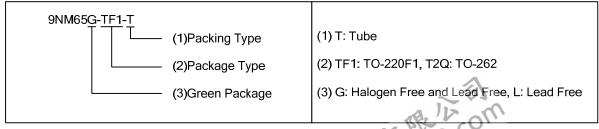




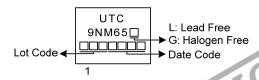
ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment			Dooking	
Lead Free	Halogen-Free	Package	1	2	3	Packing	
9NM65L-TF1-T	9NM65G-TF1-T	TO-220F1	G	D	S	Tube	
9NM65L-T2Q-T	9NM65G-T2Q-T	TO-262	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	650	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous	I_{D}	9	Α	
	Pulsed (Note 2)	I_{DM}	18	Α	
Avalanche Energy Single Pulsed (Note 3)		E _{AS}	346	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	6	V/ns	
Power Dissipation	TO-220F1	D	46	W	
	TO-262	P_D	154	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T_{STG}	-55 ~ + 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=60mH, I_{AS} =3.4A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 9.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	62.5	°C/W
Junction to Case	TO-220F1	0	2.72	°C/W
	TO-262	θ_{JC}	0.81	°C/W



ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	650			V	
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V$			10	μΑ	
Gate- Source Leakage Current	Forward	I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA	
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		3.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10V, I_D = 4.5A$			0.62	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C _{ISS}			810		pF	
Output Capacitance		Coss	V_{GS} =0V, V_{DS} =25V, f=1MHz		365		pF	
Reverse Transfer Capacitance		C _{RSS}			25		pF	
SWITCHING CHARACTERISTICS								
Total Gate Charge (Note 1)		Q_{G}	V _{DS} =150V, V _{GS} =10V, I _D =5A		24		nC	
Gateource Charge		Q_GS	I _G =3mA (Note 1, 2)		4.8		nC	
Gate-Drain Charge		Q_GD	IG-SITIA (NOTE 1, 2)		6.6		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			6		ns	
Rise Time		t_R	V_{DD} =80V, V_{GS} =10V, I_{D} =8A,		22		ns	
Turn-OFF Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		110		ns	
Fall-Time		t_{F}			50		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		Is				9	Α	
Maximum Body-Diode Pulsed Current		I _{SM}				18	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =9A, V _{GS} =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =9A, V _{GS} =0V,		250		ns	
Body Diode Reverse Recovery Charge		Q _{rr}	dI _F /dt=100A/μs		2.2		μC	

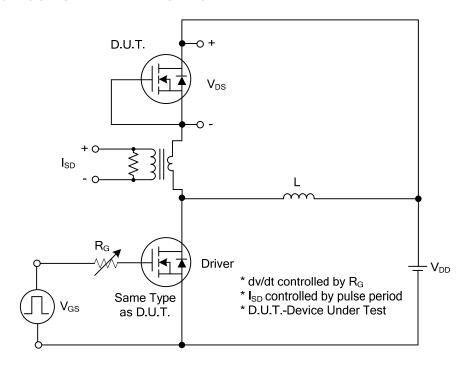
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.



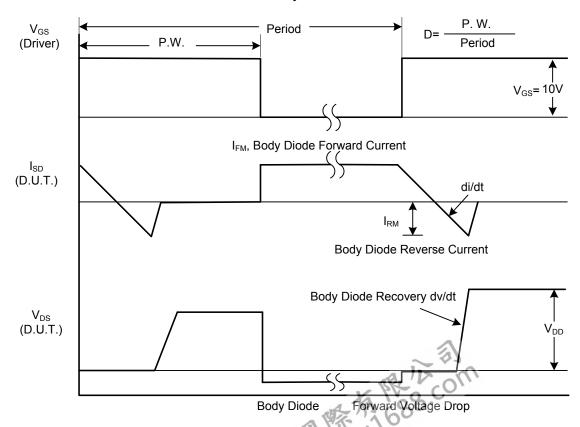
^{2.} Essentially independent of operating temperature.

9NM65-V Power MOSFET

■ TEST CIRCUITS AND WAVEFORMS



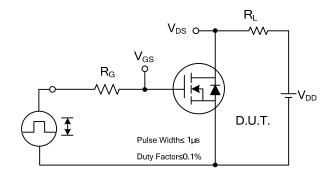
Peak Diode Recovery dv/dt Test Circuit



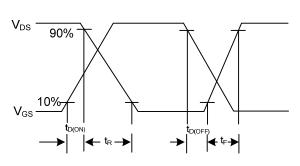
Peak Diode Recovery dw/dt Waveforms

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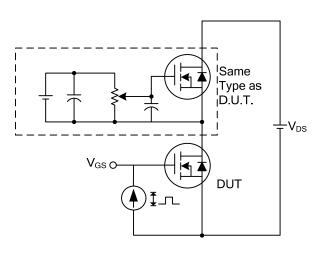
TEST CIRCUITS AND WAVEFORMS



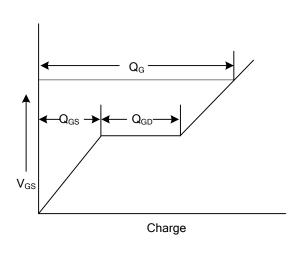
Switching Test Circuit



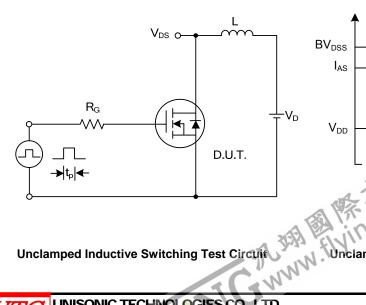
Switching Waveforms

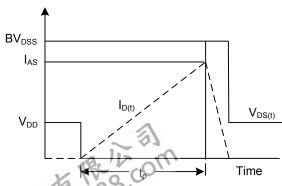


Gate Charge Test Circuit



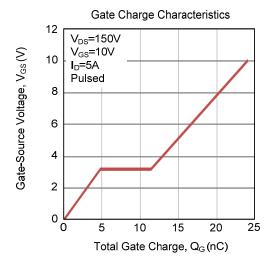
Gate Charge Waveform





Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



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